# **SPECIFICATION**

Revision: 0.0

WKS70170-B

This module uses ROHS material

This specification may change without prior notice in order to improve performance or quality. Please contact WKS R&D department for updated specification and product status before design for this product or release of this order.

WRITTEN BY	CHECKED BY	APPROVED BY
Sandy	Eric	Jason

# **REVISION RECORD**

ARKS
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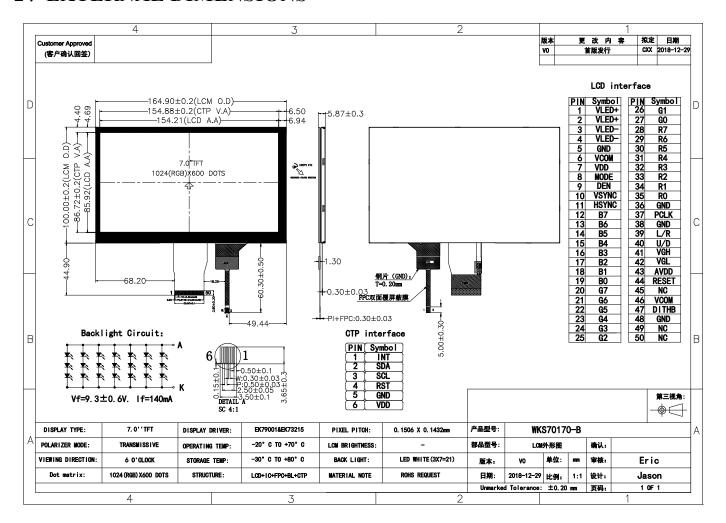
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# **1. GENERAL INFORMATION**

Item of general information	Contents	Unit
LCD Display Size (Diagonal)	7.0	inch
LCD Display Type	TFT/TRANSMISSIVE	-
LCD Display Mode	Normally White	-
Recommended Viewing Direction	12	o'clock
Gray inversion Direction	6	o'clock
Module size (W×H×T)	164.90×100.00×5.87	mm
Active area (W×H)	154.2144×85.92	mm
Number of pixels (Resolution)	1024(RGB)×600	pixel
Pixel pitch (W×H)	0.1506×0.1432	mm
Color Pixel Arrangement	RGB Stripe	-
LCD Driver IC	-	-
Interface Type	24bit Parallel RGB interface	-
Color Numbers	16.7M	-
Backlight Type	White LED	-

### 2 EXTERNAL DIMENSIONS



### 3, ABSOLUTE MAXIMUM RATINGS

Parameter of absolute maximum ratings	Symbol	Min	Max	Unit
LCD supply voltage	VDD	-0.5	5.0	V
Operating temperature	Тор	-20	70	°C
Storage temperature	Tst	-30	80	°C
Humidity	RH	-	90%(Max 60°C)	RH

Note: Absolute maximum ratings mean the product can withstand short-term, not more than 120 hours. If it is a long time to withstand these conditions, the life time would be shorter.

### 4、ELECTRICAL CHARACTERISTICS(DC CHARACTERISTICS)

Parameter of DC characteristics	Symbol	Min.	Тур.	Max.	Unit	Note
Digital Supply Voltage	VDD	3.0	3.3	3.6	V	
Analog Supply Voltage	AVDD	9.4	9.6	9.8	V	
Gate On Voltage	VGH	16	18	20	V	
Gate Off Voltage	VGL	-5	-6	-7	V	
Common Voltage	VCOM	3.4	3.5	3.6	V	Note1
Input voltage 'H' level	VIH	0.7*VDD	-	VDD	V	
Input voltage 'L' level	VIL	VSS	-	0.3*VDD	V	
Output voltage 'H' level	VOH	VDD-0.4	-	VDD	V	
Output voltage 'L' level	VOL	VSS	-	VSS+0.4	V	
Digital current	$I_{V\!D\!D}$	-	30	-	mA	
Analog current	$I_{\scriptscriptstyle AVDD}$	-	35	-	mA	
Gate On current	$I_{VGH}$	-	0.5	-	mA	
Gate Off current	$I_{\scriptscriptstyle V\!G\!L}$	-	0.5	-	mA	

Note 1: Please adjust VCOM voltage to make the flicker level be minimum.

### **5** BACKLIGHT CHARACTERISTICS

Item of backlight characteristics	Symbol	Min.	Тур.	Max.	Unit	Remark
Forward Voltage	Vf	8.7	9.3	9.9	V	Note1
Forward Current	If	-	140	-	mA	-
Number of LED	-	ı	3*7=21	-	Piece	-
LED Connection mode	P/S	ı	Serial/Parallel	-	_	-
Lifetime of LED	_	-	15000	-	hour	Note2

- Note1: The LED Supply Voltage is defined by the number of LED at Ta=25 °C and If=140mA.
- Note2: The LED lifetime define as the estimated time to 50% degradation of initial luminous. The LED lifetime could be decreased if operating If is larger than 140mA.

# **6. TOUCH CHARACTERISTICS**

Item of CTP	Specification	Unit	Remark
Panel Type	Glass Cover + Glass Sensor	-	-
Resolution	$1024 \times 600$	pixel	-
Surface Hardness	≥6H	-	-
Transparency	>82%	-	-
Driver IC	-	-	-
Interface Type	I2C	-	-
Support Points	5(Max)	-	-
Sampling Rate	20~100	Hz	-
Supply voltage	3.3	V	-

#### 7. ELECTRO-OPTICAL CHARACTERISTICS

Item (		Sh al	Caralitian	M	Т	Mass	TT24	Damada	Nata
electro-op		Symbol	Condition	Min.	Тур.	Max.	Unit	Remark	Note
Response	time	Tr+Tf	0.0	-	25	40	ms	FIG 1.	4
Contrast F	Ratio	CR	θ=0 ∅=0	-	400	-	-	FIG 2.	1
Luminance un	iformity	δWHITE	Ta=25°C	-	80	-	%	FIG 2.	3
Surface Lum	inance	Lv		-	300	-	cd/m2	FIG 2.	2
	White	White x	θ=0 Ø=0 Ta=25°C	-	0.300	-	_	FIG 2.	
	Willie	White y		-	0.340	-			5
	Red	Red x		-	0.615	-			
CIE (x, y)		Red y		-	0.320	-			
chromaticity	Green	Green x		_	0.296	-			
	Green	Green y	14 25 0	-	0.569	_			
	D1	Blue x		-	0.142	-			
	Blue	Blue y		-	0.174	-			
	Ø=90(1	2 o'clock)		-	60	_	deg		
Viewing	Ø=270(	6 o'clock)	$CR \ge 10$	-	70	-	deg deg	EIC 2	
angle range	Ø=0(3 d	o'clock)	CK ≥ 10	-	80	-		FIG 3.	6
	Ø=180(	9 o'clock)		-	80	-	deg		
NTSC ratio		-	-	-	50	_	%	-	-

**Note 1.** Contrast Ratio(CR) is defined mathematically by the following formula. For more information see FIG 2.:

 $Contrast\ Ratio(CR) = \frac{Average\ Surface\ Luminance\ with\ all\ white\ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}{Average\ Surface\ Luminance\ with\ all\ black\ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}$ 

**Note 2.** Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv=Average Surface Luminance with all white pixels (P1,P2,P3,P4,P5,P6,P7,P8,P9)

**Note 3.** The uniformity in surface luminance (δWHITE) is determined by measuring luminance at each test position 1 through 9, and then dividing the maximum luminance of

9points luminance by minimum luminance of 9 points luminance. For more information see FIG 2.

$$\delta \text{WHITE} = \frac{\textit{Minimum Surface Luminance with all white pixels} (P1, P2, P3, P4, P5, P6, P7, P8, P9)}{\textit{Maximum Surface Luminance with all white pixels} (P1, P2, P3, P4, P5, P6, P7, P8, P9)}$$

**Note 4.** Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1.

**Note 5.** CIE (x, y) chromaticity, The x,y value is determined by screen active area position 5. For more information see FIG 2.

**Note 6.** Viewing angle is the angle at which the contrast ratio is greater than a specific value. For TFT module, the specific value of contrast ratio is 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

**Note 7.** For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on BM-7 photo detector.

**Note 8.** For TN type TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing angle.

### FIG.1. The definition of Response Time

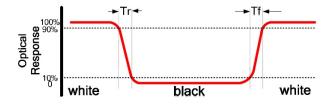


FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance uniformity, CIE (x, y) chromaticity

A: H/6; B: V/6;

H,V: Active Area(AA) size

Measurement instrument: BM-7; Light spot size=5mm, 350mm distance from the LCD surface to detector lens.

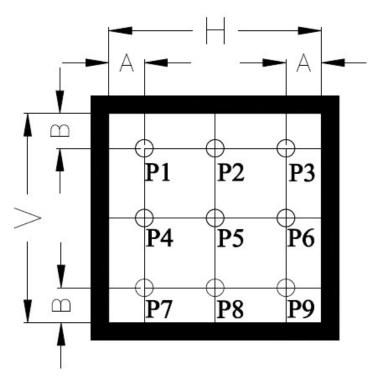
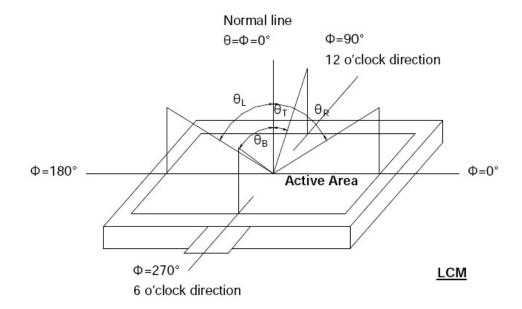


FIG.3. The definition of viewing angle



# **8. INTERFACE DESCRIPTION**

# **A.** LCD Interface Description

NO.	Symbol	I/O	DESCRIPTION
1~2	LED-A	Power supply	Backlight Anode
3~4	LED-K	Power supply	Backlight Cathode
5	GND	Power supply	Power ground
6	VCOM	I	For external VCOM DC input
7	VDD	Power supply	Digital Power supply
8	MODE	I	DE/SYNC mode select. H:DE mode; L:HSD/VSD mode.
9	DEN	I	Data input Enable. Active high to enable the data input Bus.
10	VSYNC	I	Vertical Sync input. Negative polarity.
11	HSYNC	I	Horizontal Sync input. Negative polarity.
12~19	B7~B0	I	8bit digital Blue data input(B7:MSB; B0:LSB)
20~27	G7~G0	I	8bit digital Green data input(G7:MSB; G0:LSB)
28~35	R7~R0	I	8bit digital Red data input(R7:MSB; R0:LSB)
36	GND	Power supply	Power ground
37	PCLK	I	Clock signal. Data latched at rising/falling edge of this signal.
38	GND	Power supply	Power ground
39	SHLR	I	Source Right or Left sequence control.
40	UPDN	I	Gate Up or Down scan control.
41	VGH	Power supply	Positive Power for TFT
42	VGL	Power supply	Negative Power for TFT
43	AVDD	Power supply	Power supply for analog circuits
44	RESET	I	LCD reset signal, Low is active
45	NC	-	No Connection
46	VCOM	I	For external VCOM DC input
47	DITHB	I	Dithering function enable control
48	GND	Power supply	Power ground
49~50	NC	-	No Connection

# **B.** TOUCH Interface Description

NO.	Symbol	I/O	DESCRIPTION
1	INT	О	CTP External interrupt to the host
2	SDA	I/O	CTP I2C data input and output
3	SCL	I	CTP I2C clock input
4	RESET	I	CTP external reset signal, Low is active
5	GND	Power supply	Power ground
6	VDD	Power supply	CTP Power input

# 9、INPUT TIMING

# HV mode input Timing table

Parameter	Symbol		Value		Unit
r ar ameter	Symbol	Min.	Тур.	Max.	Unit
DCLK frequency@ Frame rate=60Hz	DCLK	44.9	51.2	63	MHz
Horizontal display area	thd		1024		DCLK
1 Horizontal Line	th	1200	1344	1400	DCLK
HSYNC pulse width	thpw	1	-	140	DCLK
HSYNC Blanking	thb	160	160	160	DCLK
HSYNC Front Porch	thfp	16	160	216	DCLK
Vertical display area	tvd	600			Н
VSYNC period time	tv	624 635 750		Н	
VSYNC pulse width	tvpw	1	-	20	Н
VSYNC Blanking	tvb	23	23	23	Н
VSYNC Front Porch	tvfp	1	12	127	Н

### **DE** mode input Timing table

Parameter	Symbol		Value		Unit	
r ar ameter	Symbol	Min.	Тур.	Max.	Cint	
DCLK frequency@ Frame rate=60Hz	DCLK	40.8	51.2	67.2	MHz	
Horizontal display area	thd	1024			DCLK	
HSYNC period time	th	1114 1344 1400			DCLK	
HSYNC Blanking	thb + thfp	90	320	376	DCLK	
Vertical display area	tvd	600			Н	
VSYNC period time	tv	610 635 800		Н		
VSYNC Blanking	tvb + tvfp	10	35	200	Н	

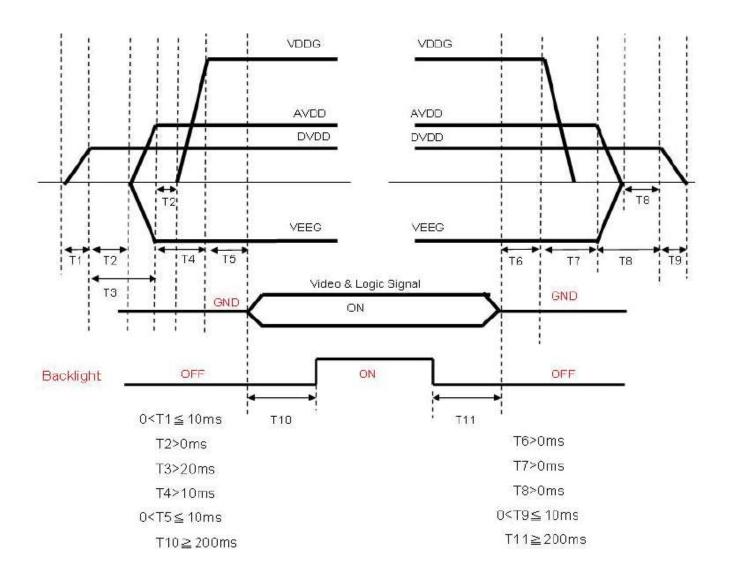
Note: Mode selection via the "MODE" pin as follows:

	<b>Default Status</b>	Н	L
MODE	Н	DE mode	HSD/VSD mode(HV mode)

# 10. POWER ON/OFF SEQUENCE

Power On: VDD→AVDD/VGL→VGH→Video & Logic Signal

Power Off: Video & Logic Signal→VGH→AVDD/VGL→VDD



# 11、RELIABILITY TEST CONDITIONS

No.	Test Item	Test Condition			
1	High Temperature Storage	80°C/120 hours			
2	Low Temperature Storage	-30°C/120 hours			
3	High Temperature Operating	70°C/120 hours			
4	Low Temperature Operating	-20°C/120 hours			
5	Temperature Cycle Storage	-20°C(30min.)~25(5min.)~70°C(30min.)×10cycles			

### A. Inspection after test:

Inspection after 2~4 hours storage at room temperature, the sample shall be free from defects:

- Air bubble in the LCD;
- Sealleak;
- ➤ Non-display;
- Missing segments;
- ➤ Glass crack;
- Current is twice higher than initial value.

#### B, Remark:

- The test samples should be applied to only one test item.
- > Sample size for each test item is  $5\sim10$  pcs.
- ➤ Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

#### 12 INSPECTION CRITERION

This specification is made to be used as the standard of acceptance/rejection criteria for TFT-LCD/IPS TFT-LCD module product, and this specification is applicable only in the case that the size of module equal to or exceed than 3.5 inch.

#### 12.1 Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993,normal level 2 and based on:

Major defect: AQL 0.65

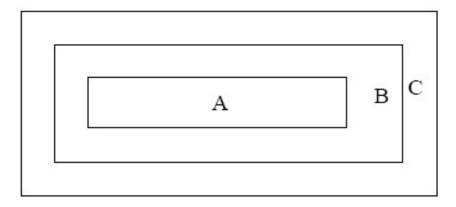
Minor defect: AQL 1.5

#### 12.2 Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line. (Normal temperature 20~25°C and normal humidity 60  $\pm 15$ %RH)

### 12.3 Definition of Inspection Item.

### **A.** Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (Zone A + Zone B=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

### **B**, Definition of some visual defect

	Because of losing all or part function, bad pixel dots appear bright and the
Bright dot	size is more than 50% of one dot in which LCD panel is displaying under
	black pattern.
D 1 1 4	Dots appear dark and unchanged in size in which LCD panel is displaying
Dark dot	under pure red, green, blue picture, or pure whiter picture.

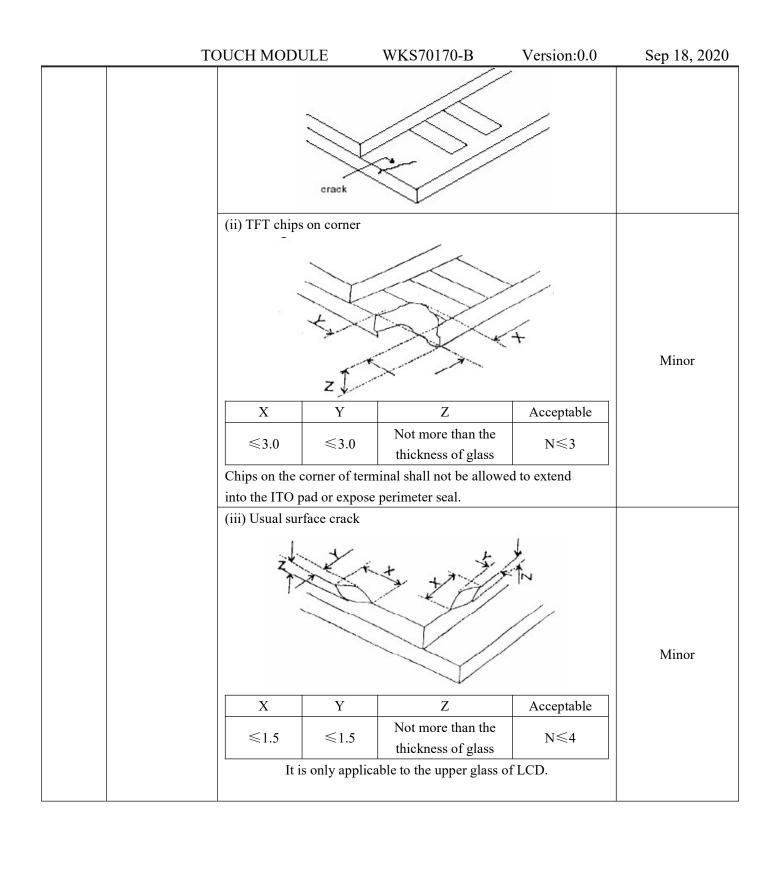
### 12.4 Major Defect

Item No.	Items to be inspected	Inspection standard	Classification of defects
1	Functional defects	1) No display 2) Display abnormally 3) Missing vertical, horizontal segment 4) Short circuit 5) Excess power consumption 6)Backlight no lighting, flickering and abnormal lighting	major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	

# 12.5 Minor Defect

Item No.	Items to be inspected	Inspection standard					Classification of defects				
				Acceptable Qty A+B							
					3.5~7" 7~10.1"			>	>10.1"	С	
		Bright pixel dot		t	1		2		3		
	Bright dot	Dark pixel dot			4		4		4	Aco	
1	/dark dot	2brigh	nt dots adja	cent	0		0		0	Acceptable	Minor
	defect	2dark	dots adjac	ent	0		0		0	able	
		Total bri	ght and da	rk dots	5		6		7		
		Pixel dots	nimum distant function indother re	is norma	ıl, but	brigh	nt dots ca	used	by foreig		
			Zone		3 0		ceptable				
				A+B							
		Size(mm)		3.5"~	~7"	7" 7~10.1"		>	10.1"	С	
	Dot defect	Ф ≤0.2		Accep	able Acceptabl		eptable	Acc	eptable	Acc	
2		0.2< Ф ≤ 0.5		4	4		5		6	Acceptable	Minor
		Ф>0.5		0			0 0		ble		
		Note: 1. Minimum distance between defective dots is more than 5 mm; 2. The quantity of defect is zero in operating condition.									
	Linear defect		Zone				ceptable				
		Size (mm)			A+B						
3		Length	Width	3.5"~	~7"	7~	~10.1"	>	10.1"	С	
		Ignore	W≤0.05	Accep	table	Acc	eptable	Acc	eptable	Ac	Minor
		L≤5.0   0.05< W≤0.1		4			5		6	Acceptable	
		L>5.0	W>0.1	0			0		0	<u>ē</u>	
				•							

	Т	OUCH MODULE	WKS	570170-В	Version	:0.0	Sep 18, 2020
4	Polarizer defect	5.4.1 Polarizer Post dimension.  (ii) Shifting in post dimension.  (ii) Incomplete coallowed.  5.4.2 Dirt on polar Dirt which can be soon to	izer wiped easily sh at & Air bubble  3.5"~7" Acceptable  4  0  ratch scratch can be g condition, juer scratch can e special angle  3.5"~7" Acceptable	Acceptable  A+B  7~10.1"  Acceptable  5  0  e seen after cadge by the libe seen only	able.  Qty  >10.1"  Acceptable  6  0  cover assembnear defect of in non-operate following:	C Acceptable sling of 5.3.	Minor
5	MURA	Using 3% ND f	Minor				
	White/Black dot (MURA)	Visible und 0.15mm <d≦< td=""><td>Minor</td></d≦<>	Minor				
6	Glass defect	(i) Crack Cracks are not a	Minor				



# 12.6 Module Cosmetic Criteria

Item No.	Items to be inspected	Inspection Standard	Classification of defects
1	Difference in Spec.	Not allowable	Major
2	Pattern peeling	No substrate pattern peeling and floating	Major
		No soldering missing	Major
3	Soldering defects	No soldering bridge	Major
		No cold soldering	Minor
4	Resist flaw on PCB	Visible copper foil ( $\Phi$ 0.5 mm or more) on substrate	Minor
4	Resist Haw OH FCB	pattern is not allowed	IVIIIIOI
5	FPC gold finger	No dirt, breaking, oxidation lead to black	Major
6	Backlight plastic frame	No deformation, crack, breaking, backlight positioning column breaking, obvious nick.	Minor
7	Marking printing effect	No dark marking, incomplete, deformation lead to unable to judge	Minor
8	Accretion of metallic Foreign matter	No accretion of metallic foreign matter (Not exceed Φ0.2mm)	Minor
9	Stain	No stain to spoil cosmetic badly	Minor
10	Plate discoloring	No plate fading, rusting and discoloring	Minor
	1. Lead parts	a. Soldering side of PCB Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly.	Minor
	1. Leau parts	b. Components side(In case of 'Through Hole PCB') Solder to reach the Components side of PCB.	Minor
	Either 'Toe'(A) or 'Seal'(B)of the lead to be covered by "Filet". Lead form to be assume over Solder.		Minor
11	3. Chips	(3/2) H ≥h ≥(1/2) H  \$\int_h \hat{\hat{h}}\$  \$\tag{h}\$	Minor
	4. Solder ball/Solder splash	a. The spacing between solder ball and the conductor or solder pad h $\geq$ 0.13 mm. The diameter of solder ball d $\leq$ 0.15 mm.	Minor
		b. The quantity of solder balls or solder splashes isn't beyond 5 in 600 mm2.	Minor
		c. Solder balls/Solder splashes do not violate minimum electrical clearance.	Major